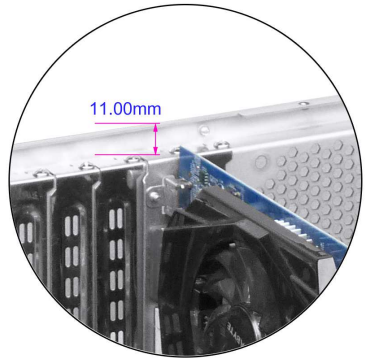
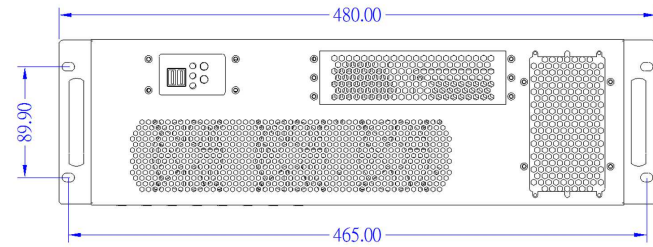
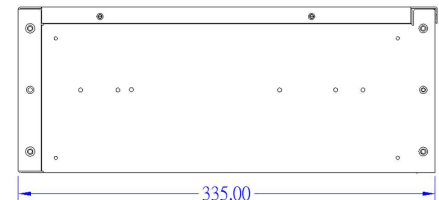
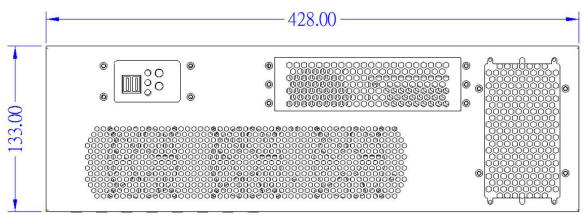
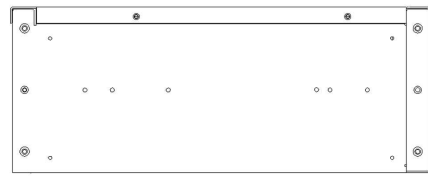
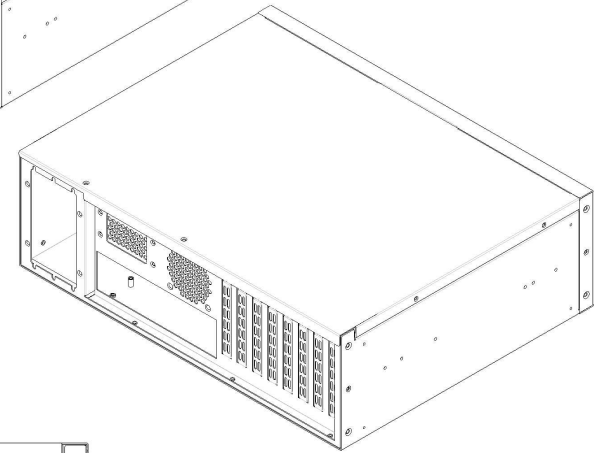
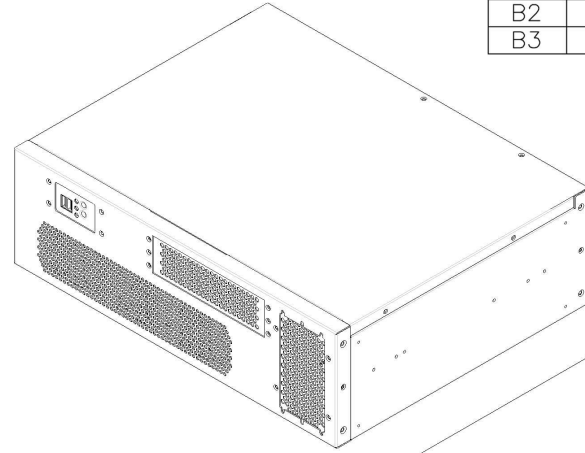
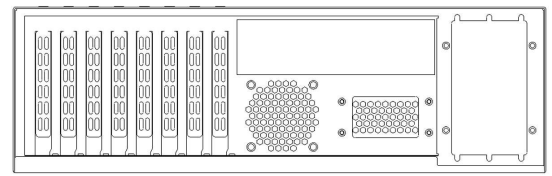
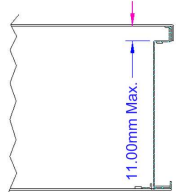


修訂 REVISIONS		日期 DATE
版次 REV.	記述 DESCRIPTION	
B2		
B3		



11.00mm

The room between top (lid) of this 3U chassis and expansion card bracket is maximum 11.00mm



容許公差: TOLERANCES:	.XXX ±.025 .XX ±.100 .X ±.250
投影法: PROJECTION:	第三角法

材料規格: MATERIAL:	SGCC 1.2mm~2.0mm thickness		
核准者: APPROVE BY:	Robert Roan	日期: DATE:	March 27, 2023
審核者: CHECK BY:	Jun Chen	日期: DATE:	March 27, 2023
繪圖者: DRAW BY:	Veness Huang	日期: DATE:	March 27, 2023

品名: MODEL NO:		3U GPU I/O front-rear access chassis	
料號: PART NO:		C335B	
圖號: DRAW NO:		檔號: FILE NO: C335B-20230327	
單位: UNITS:	mm	版次: REV. NO:	0.0
規格: SPEC.:		編號: SHEET:	0F

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